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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixedfunction ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

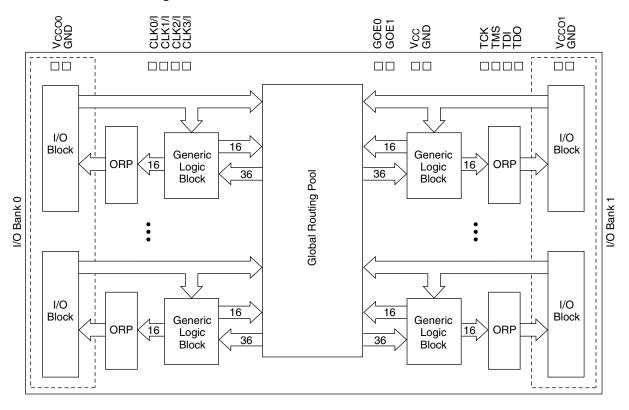
Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	3.5 ns
Voltage Supply - Internal	2.3V ~ 2.7V
Number of Logic Elements/Blocks	24
Number of Macrocells	384
Number of Gates	-
Number of I/O	128
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-TQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4384b-35t176c

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Figure 1. Functional Block Diagram



The I/Os in the ispMACH 4000 are split into two banks. Each bank has a separate I/O power supply. Inputs can support a variety of standards independent of the chip or bank power supply. Outputs support the standards compatible with the power supply provided to the bank. Support for a variety of standards helps designers implement designs in mixed voltage environments. In addition, 5V tolerant inputs are specified within an I/O bank that is connected to V_{CCO} of 3.0V to 3.6V for LVCMOS 3.3, LVTTL and PCI interfaces.

ispMACH 4000 Architecture

There are a total of two GLBs in the ispMACH 4032, increasing to 32 GLBs in the ispMACH 4512. Each GLB has 36 inputs. All GLB inputs come from the GRP and all outputs from the GLB are brought back into the GRP to be connected to the inputs of any other GLB on the device. Even if feedback signals return to the same GLB, they still must go through the GRP. This mechanism ensures that GLBs communicate with each other with consistent and predictable delays. The outputs from the GLB are also sent to the ORP. The ORP then sends them to the associated I/O cells in the I/O block.

Generic Logic Block

The ispMACH 4000 GLB consists of a programmable AND array, logic allocator, 16 macrocells and a GLB clock generator. Macrocells are decoupled from the product terms through the logic allocator and the I/O pins are decoupled from macrocells through the ORP. Figure 2 illustrates the GLB.

Product Term Allocator

The product term allocator assigns product terms from a cluster to either logic or control applications as required by the design being implemented. Product terms that are used as logic are steered into a 5-input OR gate associated with the cluster. Product terms that used for control are steered either to the macrocell or I/O cell associated with the cluster. Table 3 shows the available functions for each of the five product terms in the cluster. The OR gate output connects to the associated I/O cell, providing a fast path for narrow combinatorial functions, and to the logic allocator.

Table 3. Individual PT Steering

Product Term	Logic	Control			
PT <i>n</i>	Logic PT	Single PT for XOR/OR			
PT <i>n</i> +1	Logic PT	Individual Clock (PT Clock)			
PT <i>n</i> +2	Logic PT	Individual Initialization or Individual Clock Enable (PT Initialization/CE)			
PT <i>n</i> +3	Logic PT	Individual Initialization (PT Initialization)			
PT <i>n</i> +4	Logic PT	Individual OE (PTOE)			

Cluster Allocator

The cluster allocator allows clusters to be steered to neighboring macrocells, thus allowing the creation of functions with more product terms. Table 4 shows which clusters can be steered to which macrocells. Used in this manner, the cluster allocator can be used to form functions of up to 20 product terms. Additionally, the cluster allocator accepts inputs from the wide steering logic. Using these inputs, functions up to 80 product terms can be created.

Table 4. Available Clusters for Each Macrocell

Macrocell		Available	Clusters	
M0	_	C0	C1	C2
M1	C0	C1	C2	C3
M2	C1	C2	C3	C4
M3	C2	C3	C4	C5
M4	C3	C4	C5	C6
M5	C4	C5	C6	C7
M6	C5	C6	C7	C8
M7	C6	C7	C8	C9
M8	C7	C8	C9	C10
M9	C8	C9	C10	C11
M10	C9	C10	C11	C12
M11	C10	C11	C12	C13
M12	C11	C12	C13	C14
M13	C12	C13	C14	C15
M14	C13	C14	C15	_
M15	C14	C15	_	_

Wide Steering Logic

The wide steering logic allows the output of the cluster allocator n to be connected to the input of the cluster allocator n+4. Thus, cluster chains can be formed with up to 80 product terms, supporting wide product term functions and allowing performance to be increased through a single GLB implementation. Table 5 shows the product term chains.

- LVTTL
- LVCMOS 1.8
- LVCMOS 3.3
- 3.3V PCI Compatible
- LVCMOS 2.5

All of the I/Os and dedicated inputs have the capability to provide a bus-keeper latch, Pull-up Resistor or Pull-down Resistor. A fourth option is to provide none of these. The selection is done on a global basis. The default in both hardware and software is such that when the device is erased or if the user does not specify, the input structure is configured to be a Pull-up Resistor.

Each ispMACH 4000 device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for fast slew or slow slew. The typical edge rate difference between fast and slow slew setting is 20%. For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed.

Global OE Generation

Most ispMACH 4000 family devices have a 4-bit wide Global OE Bus, except the ispMACH 4032 device that has a 2-bit wide Global OE Bus. This bus is derived from a 4-bit internal global OE PT bus and two dual purpose I/O or GOE pins. Each signal that drives the bus can optionally be inverted.

Each GLB has a block-level OE PT that connects to all bits of the Global OE PT bus with four fuses. Hence, for a 256-macrocell device (with 16 blocks), each line of the bus is driven from 16 OE product terms. Figures 9 and 10 show a graphical representation of the global OE generation.

Figure 9. Global OE Generation for All Devices Except ispMACH 4032

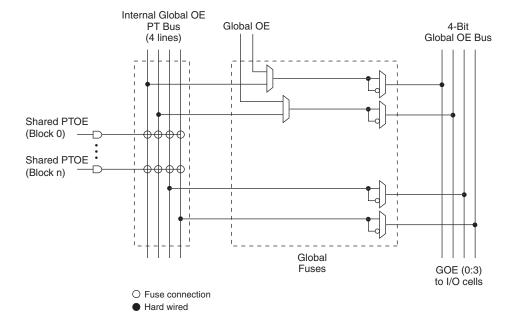
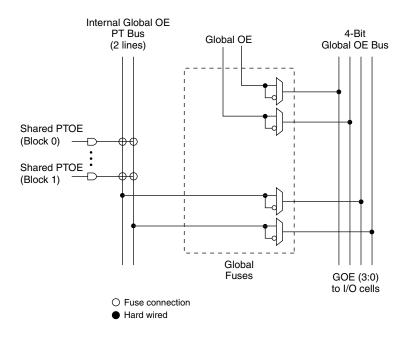


Figure 10. Global OE Generation for ispMACH 4032



Zero Power/Low Power and Power Management

The ispMACH 4000 family is designed with high speed low power design techniques to offer both high speed and low power. With an advanced E² low power cell and non sense-amplifier design approach (full CMOS logic approach), the ispMACH 4000 family offers SuperFAST pin-to-pin speeds, while simultaneously delivering low standby power without needing any "turbo bits" or other power management schemes associated with a traditional sense-amplifier approach.

The zero power ispMACH 4000Z is based on the 1.8V ispMACH 4000C family. With innovative circuit design changes, the ispMACH 4000Z family is able to achieve the industry's "lowest static power".

IEEE 1149.1-Compliant Boundary Scan Testability

All ispMACH 4000 devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic notes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port operates with an LVCMOS interface that corresponds to the power supply voltage.

I/O Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os' physical nature should be minimal so that board test time is minimized. The ispMACH 4000 family of devices allows this by offering the user the ability to quickly configure the physical nature of the I/O cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice's ispVM[®] System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

I/O Recommended Operating Conditions

	V _{CCO} (V) ¹				
Standard	Min.	Max.			
LVTTL	3.0	3.6			
LVCMOS 3.3	3.0	3.6			
Extended LVCMOS 3.3 ²	2.7	3.6			
LVCMOS 2.5	2.3	2.7			
LVCMOS 1.8	1.65	1.95			
PCI 3.3	3.0	3.6			

^{1.} Typical values for $\rm V_{\rm CCO}$ are the average of the min. and max. values.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
I _{IL} , I _{IH} ^{1, 4}	Input Leakage Current (ispMACH 4000Z)	$0 \le V_{IN} < V_{CCO}$	_	0.5	1	μΑ
I _{IH} ¹	Input High Leakage Current (isp-MACH 4000Z)	$V_{CCO} < V_{IN} \le 5.5V$	_	_	10	μΑ
I _{IL} , I _{IH} ¹	Input Leakage Current (ispMACH	$0 \le V_{IN} \le 3.6V, T_j = 105^{\circ}C$	_	_	10	μΑ
'IL', 'IH	4000V/B/C)	$0 \le V_{IN} \le 3.6V, T_j = 130^{\circ}C$	_	_	15	μΑ
I _{IH} ^{1,2}	Input High Leakage Current (isp-	$3.6V < V_{IN} \le 5.5V$, $T_j = 105^{\circ}C$ $3.0V \le V_{CCO} \le 3.6V$	_	_	20	μΑ
ΊΗ	MACH 4000V/B/C)	$3.6V < V_{IN} \le 5.5V$, $T_j = 130^{\circ}C$ $3.0V \le V_{CCO} \le 3.6V$	_	_	50	μΑ
I	I/O Weak Pull-up Resistor Current (ispMACH 4000Z)	$0 \le V_{IN} \le 0.7 V_{CCO}$	-30	_	-150	μΑ
I _{PU}	I/O Weak Pull-up Resistor Current (ispMACH 4000V/B/C)	$0 \le V_{IN} \le 0.7 V_{CCO}$	-30	_	-200	μΑ
I _{PD}	I/O Weak Pull-down Resistor Current	V_{IL} (MAX) $\leq V_{IN} \leq V_{IH}$ (MIN)	30	_	150	μΑ
I _{BHLS}	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL} (MAX)$	30		_	μΑ
I _{BHHS}	Bus Hold High Sustaining Current	$V_{IN} = 0.7 V_{CCO}$	-30	_	_	μΑ
I _{BHLO}	Bus Hold Low Overdrive Current	$0V \le V_{IN} \le V_{BHT}$	_	_	150	μΑ
I _{BHHO}	Bus Hold High Overdrive Current	$V_{BHT} \le V_{IN} \le V_{CCO}$	_	_	-150	μΑ
V_{BHT}	Bus Hold Trip Points	_	V _{CCO} * 0.35	_	V _{CCO} * 0.65	V
C ₁	I/O Capacitance ³	V _{CCO} = 3.3V, 2.5V, 1.8V	_	8	_	pf
01	1/O Capacitance	$V_{CC} = 1.8V$, $V_{IO} = 0$ to V_{IH} (MAX)	_	U	_	рі
C_2	Clock Capacitance ³	V _{CCO} = 3.3V, 2.5V, 1.8V	_	6	_	pf
02	Clock Capacitarios	$V_{CC} = 1.8V$, $V_{IO} = 0$ to V_{IH} (MAX)	_	J	_	ρı
C ₃	Global Input Capacitance ³	V _{CCO} = 3.3V, 2.5V, 1.8V	_	6	_	pf
0 3	Global Input Gapasitario	$V_{CC} = 1.8V$, $V_{IO} = 0$ to V_{IH} (MAX)	_		_	Pi

^{1.} Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tristated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

^{2.} ispMACH 4000Z only.

^{2. 5}V tolerant inputs and I/O should only be placed in banks where 3.0V \leq V $_{CCO} \leq$ 3.6V.

^{3.} $T_A = 25^{\circ}C$, f = 1.0MHz

^{4.} I_{II} excursions of up to 1.5μA maximum per pin above the spec limit may be observed for certain voltage conditions on no more than 10% of the device's I/O pins.

I/O DC Electrical Characteristics

Over Recommended Operating Conditions

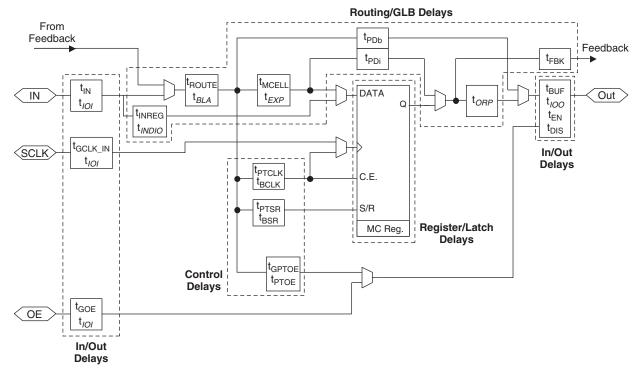
	V _{IL}		V _{IH}	V _{IH}			l _{OL} ¹	I _{OH} ¹
Standard	Min (V)	Max (V)	Min (V)	Max (V)	V _{OL} Max (V)	V _{OH} Min (V)	(mA)	(mA)
LVTTL	-0.3	0.80	2.0	5.5	0.40	V _{CCO} - 0.40	8.0	-4.0
LVIIL	-0.5	0.00	2.0	5.5	0.20	V _{CCO} - 0.20	0.1	-0.1
LVCMOS 3.3	-0.3	0.80	2.0	5.5	0.40	V _{CCO} - 0.40	8.0	-4.0
EVOIVIOU 3.3	-0.5	0.00	2.0	5.5	0.20	V _{CCO} - 0.20	0.1	-0.1
LVCMOS 2.5	-0.3	-0.3 0.70	1.70	3.6	0.40	V _{CCO} - 0.40	8.0	-4.0
EVOIVIOU 2.5	-0.0	0.70	1.70		0.20	V _{CCO} - 0.20	0.1	-0.1
LVCMOS 1.8	-0.3	0.63	1.17	3.6	0.40	V _{CCO} - 0.45	2.0	-2.0
(4000V/B)	-0.5	0.03	1.17	3.0	0.20	V _{CCO} - 0.20	0.1	-0.1
LVCMOS 1.8	-0.3	0.35 * V _{CC}	0.65 * V _{CC}	3.6	0.40	V _{CCO} - 0.45	2.0	-2.0
(4000C/Z)	-0.5	0.55 V _{CC}	0.03 VCC	0.65 V _{CC} 3.6		V _{CCO} - 0.20	0.1	-0.1
PCI 3.3 (4000V/B)	-0.3	1.08	1.5	5.5	0.1 V _{CCO}	0.9 V _{CCO}	1.5	-0.5
PCI 3.3 (4000C/Z)	-0.3	0.3 * 3.3 * (V _{CC} / 1.8)	0.5 * 3.3 * (V _{CC} / 1.8)	5.5	0.1 V _{CCO}	0.9 V _{CCO}	1.5	-0.5

^{1.} The average DC current drawn by I/Os between adjacent bank GND connections, or between the last GND in an I/O bank and the end of the I/O bank, as shown in the logic signals connection table, shall not exceed *n**8mA. Where *n* is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

Timing Model

The task of determining the timing through the ispMACH 4000 family, like any CPLD, is relatively simple. The timing model provided in Figure 11 shows the specific delay paths. Once the implementation of a given function is determined either conceptually or from the software report file, the delay path of the function can easily be determined from the timing model. The Lattice design tools report the timing delays based on the same timing model for a particular design. Note that the internal timing parameters are given for reference only, and are not tested. The external timing parameters are tested and guaranteed for every device. For more information on the timing model and usage, refer to TN1004, ispMACH 4000 Timing Model Design and Usage Guidelines.

Figure 11. ispMACH 4000 Timing Model



Note: Italicized items are optional delay adders.

ispMACH 4000V/B/C/Z Power Supply and NC Connections¹

Signal	44-pin TQFP ²	48-pin TQFP ²	56-ball csBGA ³	100-pin TQFP ²	128-pin TQFP ²
VCC	11, 33	12, 36	K2, A9	25, 40, 75, 90	32, 51, 96, 115
VCCO0 VCCO (Bank 0)	6	6	F3	13, 33, 95	3, 17, 30, 41, 122
VCCO1 VCCO (Bank 1)	28	30	E8	45, 63, 83	58, 67, 81, 94, 105
GND	12, 34	13, 37	H3, C8	1, 26, 51, 76	1, 33, 65, 97
GND (Bank 0)	5	5	D3	7, 18, 32, 96	10, 24, 40, 113, 123
GND (Bank 1)	27	29	G8	46, 57, 68, 82	49, 59, 74, 88, 104
NC	_	_	4032Z : A8, B10, E1, E3, F8, F10, J1, K3	_	_

^{1.} All grounds must be electrically connected at the board level. However, for the purposes of I/O current loading, grounds are associated with the bank shown.

^{2.} Pin orientation follows the conventional order from pin 1 marking of the top side view and counter-clockwise.

^{3.} Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

ispMACH 4032V/B/C and 4064V/B/C Logic Signal Connections: 44-Pin TQFP (Cont.)

		ispMACH	4032V/B/C	ispMACH	4064V/B/C
Pin Number	Bank Number	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
42	0	A2	A^2	A4	A^2
43	0	A3	A^3	A6	A^3
44	0	A4	A^4	A8	A^4

ispMACH 4032V/B/C/Z and 4064V/B/C/Z Logic Signal Connections: 48-Pin TQFP

Pin	Bank	ispMACH 4	032V/B/C/Z	ispMACH 4	4064V/B/C	ispMACI	1 4064Z
Number	Number	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	TDI	-	TDI	-	TDI	-
2	0	A 5	A^5	A10	A^5	A8	A^5
3	0	A6	A^6	A12	A^6	A10	A^6
4	0	A7	A^7	A14	A^7	A11	A^7
5	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
6	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
7	0	A8	A^8	В0	B^0	B15	B^7
8	0	A9	A^9	B2	B^1	B12	B^6
9	0	A10	A^10	B4	B^2	B10	B^5
10	0	A11	A^11	B6	B^3	B8	B^4
11	-	TCK	-	TCK	-	TCK	-
12	-	VCC	-	VCC	-	VCC	-
13	-	GND	-	GND	-	GND	-
14	0	A12	A^12	B8	B^4	B6	B^3
15	0	A13	A^13	B10	B^5	B4	B^2
16	0	A14	A^14	B12	B^6	B2	B^1
17	0	A15	A^15	B14	B^7	В0	B^0
18	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
19	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
20	1	В0	B^0	C0	C^0	C0	C^0
21	1	B1	B^1	C2	C^1	C1	C^1
22	1	B2	B^2	C4	C^2	C2	C^2
23	1	B3	B^3	C6	C^3	C4	C^3
24	1	B4	B^4	C8	C^4	C6	C^4
25	-	TMS	-	TMS	-	TMS	-
26	1	B5	B^5	C10	C^5	C8	C^5
27	1	B6	B^6	C12	C^6	C10	C^6
28	1	B7	B^7	C14	C^7	C11	C^7
29	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
30	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
31	1	B8	B^8	D0	D^0	D15	D^7
32	1	В9	B^9	D2	D^1	D12	D^6

ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections: 100-Pin TQFP (Cont.)

	Bank	ispMACH 40	64V/B/C/Z	ispMACH 41	28V/B/C/Z	ispMACH 42	56V/B/C/Z
Pin Number	Number	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
42	1	C1	C^1	E2	E^1	16	I^1
43	1	C2	C^2	E4	E^2	I10	I^2
44	1	C3	C^3	E6	E^3	l12	I^3
45	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
46	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
47	1	C4	C^4	E8	E^4	J2	J^0
48	1	C5	C^5	E10	E^5	J6	J^1
49	1	C6	C^6	E12	E^6	J10	J^2
50	1	C7	C^7	E14	E^7	J12	J^3
51	-	GND	-	GND	-	GND	-
52	-	TMS	-	TMS	-	TMS	-
53	1	C8	C^8	F0	F^0	K12	K^3
54	1	C9	C^9	F2	F^1	K10	K^2
55	1	C10	C^10	F4	F^2	K6	K^1
56	1	C11	C^11	F6	F^3	K2	K^0
57	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
58	1	C12	C^12	F8	F^4	L12	L^3
59	1	C13	C^13	F10	F^5	L10	L^2
60	1	C14	C^14	F12	F^6	L6	L^1
61	1	C15	C^15	F13	F^7	L4	L^0
62*	1	I	-	I	-	I	-
63	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
64	1	D15	D^15	G14	G^7	M4	M^0
65	1	D14	D^14	G12	G^6	M6	M^1
66	1	D13	D^13	G10	G^5	M10	M^2
67	1	D12	D^12	G8	G^4	M12	M^3
68	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
69	1	D11	D^11	G6	G^3	N2	N^0
70	1	D10	D^10	G5	G^2	N6	N^1
71	1	D9	D^9	G4	G^1	N10	N^2
72	1	D8	D^8	G2	G^0	N12	N^3
73*	1	I	-	I	-	I	-
74	-	TDO	-	TDO	-	TDO	-
75	-	VCC	-	VCC	-	VCC	-
76	-	GND	-	GND	-	GND	-
77*	1	I	-	I	-	I	-
78	1	D7	D^7	H13	H^7	O12	O^3
79	1	D6	D^6	H12	H^6	O10	O^2
80	1	D5	D^5	H10	H^5	O6	O^1
81	1	D4	D^4	H8	H^4	02	O^0
82	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-

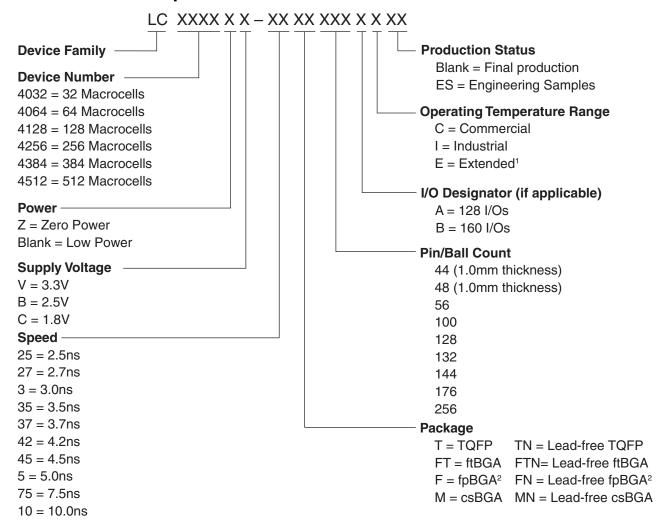
ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP (Cont.)

		ispMACH	4128V	ispMACH	4256V
Pin Number	Bank Number	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
43	0	D9	D^7	G4	G^2
44	0	D8	D^6	G2	G^1
45	0	NC ²	-	²	-
46	0	GND (Bank 0)	-	GND (Bank 0)	-
47	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
48	0	D6	D^5	H12	H^6
49	0	D5	D^4	H10	H^5
50	0	D4	D^3	H8	H^4
51	0	D2	D^2	H6	H^3
52	0	D1	D^1	H4	H^2
53	0	D0	D^0	H2	H^1
54	0	CLK1/I	-	CLK1/I	-
55	1	GND (Bank 1)	-	GND (Bank 1)	-
56	1	CLK2/I	-	CLK2/I	-
57	-	VCC	-	VCC	-
58	1	E0	E^0	12	I^1
59	1	E1	E^1	14	I^2
60	1	E2	E^2	16	I^3
61	1	E4	E^3	18	I^4
62	1	E5	E^4	I10	I^5
63	1	E6	E^5	l12	I^6
64	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
65	1	GND (Bank 1)	-	GND (Bank 1)	-
66	1	E8	E^6	J2	J^1
67	1	E9	E^7	J4	J^2
68	1	E10	E^8	J6	J^3
69	1	E12	E^9	J8	J^4
70	1	E13	E^10	J10	J^5
71	1	E14	E^11	J12	J^6
72	1	NC ²	-	 2	-
73	-	GND	-	GND	-
74	-	TMS	-	TMS	-
75	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
76	1	F0	F^0	K12	K^6
77	1	F1	F^1	K10	K^5
78	1	F2	F^2	K8	K^4
79	1	F4	F^3	K6	K^3
80	1	F5	F^4	K4	K^2
81	1	F6	F^5	K2	K^1
82	1	GND (Bank 1)	-	GND (Bank 1)	-
83	1	F8	F^6	L14	L^7
84	1	F9	F^7	L12	L^6
85	1	F10	F^8	L10	L^5

ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections: 256-Ball ftBGA/fpBGA (Cont.)

Ball	I/O	ispMACH 4256 128-I/O	V/B/C	ispMACH 4256 160-I/O	V/B/C	ispMACH 4384	V/B/C	ispMACH 4512	V/B/C
Number	Bank	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
R14	1	J10	J^5	J10	J^7	N10	N^5	BX10	BX^5
P13	1	J12	J^6	J12	J^8	N12	N^6	BX12	BX^6
N13	1	J14	J^7	J14	J^9	N14	N^7	BX14	BX^7
M12	1	NC	-	NC	-	P4	P^2	FX0	FX^0
T15	1	NC	-	NC	-	P6	P^3	FX2	FX^1
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
-	1	-	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
P14	-	TMS	-	TMS	-	TMS	-	TMS	-
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
L12	1	NC	-	NC	-	NC	-	FX4	FX^2
R16	1	NC	-	NC	-	P8	P^4	FX6	FX^3
N14	1	NC	-	NC	-	P10	P^5	FX8	FX^4
P15	1	K14	K^7	K14	K^9	O14	O^7	CX14	CX^7
L11	1	K12	K^6	K12	K^8	012	O^6	CX12	CX^6
P16	1	K10	K^5	K10	K^7	O10	O^5	CX10	CX^5
K11	1	K8	K^4	K9	K^6	O8	0^4	CX8	CX^4
M14	1	K6	K^3	K8	K^5	O6	O^3	CX6	CX^3
K12	1	K4	K^2	K6	K^4	O4	O^2	CX4	CX^2
N15	1	K2	K^1	K4	K^3	O2	O^1	CX2	CX^1
N16	1	K0	K^0	K2	K^2	00	O^0	CX0	CX^0
M15	1	NC	-	K1	K^1	BX6	BX^3	HX0	HX^0
M13	1	NC	-	K0	K^0	BX4	BX^2	HX4	HX^1
-	1	-	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
M16	1	NC	-	NC	-	NC	-	FX10	FX^5
L15	1	NC	-	NC	-	P12	P^6	FX12	FX^6
L16	1	NC	-	NC	-	P14	P^7	FX14	FX^7
J11	1	NC	-	L14	L^9	BX2	BX^1	HX8	HX^2
K15	1	NC	-	L12	L^8	BX0	BX^0	HX12	HX^3
J12	1	L14	L^7	L10	L^7	AX14	AX^7	GX14	GX^7
K13	1	L12	L^6	L9	L^6	AX12	AX^6	GX12	GX^6
K14	1	L10	L^5	L8	L^5	AX10	AX^5	GX10	GX^5
K16	1	L8	L^4	L6	L^4	AX8	AX^4	GX8	GX^4
J16	1	L6	L^3	L4	L^3	AX6	AX^3	GX6	GX^3
J15	1	L4	L^2	L2	L^2	AX4	AX^2	GX4	GX^2
H16	1	L2	L^1	L1	L^1	AX2	AX^1	GX2	GX^1
J13	1	L0	L^0	L0	L^0	AX0	AX^0	GX0	GX^0
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
-	1	-	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
J14	1	MO	M^0	MO	M^0	DX0	DX^0	JX0	JX^0

Part Number Description



- 1. For automotive AEC-Q100 compliant devices, refer to the LA-ispMACH 4000V/Z Automotive Family Data Sheet (DS1017).
- 2. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000 Family Speed Grade Offering

	-25	-27	-3	-35	-37	-42	-45	-;	5		-75		-10
	Com	Ind	Com	Ind	Ext	Ind							
ispMACH 4032V/B/C												1	
ispMACH 4064V/B/C												1	
ispMACH 4128V/B/C												1	
ispMACH 4256V/B/C													
ispMACH 4384V/B/C													
ispMACH 4512V/B/C													
ispMACH 4032ZC												1	
ispMACH 4064ZC												1	
ispMACH 4128ZC												1	
ispMACH 4256ZC													

1. 3.3V only.

ispMACH 4000V (3.3V) Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
	LC4128V-27T144C	128	3.3	2.7	TQFP	144	96	С
	LC4128V-5T144C	128	3.3	5	TQFP	144	96	С
	LC4128V-75T144C	128	3.3	7.5	TQFP	144	96	С
	LC4128V-27T128C	128	3.3	2.7	TQFP	128	92	С
LC4128V	LC4128V-5T128C	128	3.3	5	TQFP	128	92	С
	LC4128V-75T128C	128	3.3	7.5	TQFP	128	92	С
	LC4128V-27T100C	128	3.3	2.7	TQFP	100	64	С
	LC4128V-5T100C	128	3.3	5	TQFP	100	64	С
	LC4128V-75T100C	128	3.3	7.5	TQFP	100	64	С
	LC4256V-3FT256AC	256	3.3	3	ftBGA	256	128	С
	LC4256V-5FT256AC	256	3.3	5	ftBGA	256	128	С
	LC4256V-75FT256AC	256	3.3	7.5	ftBGA	256	128	С
	LC4256V-3FT256BC	256	3.3	3	ftBGA	256	160	С
	LC4256V-5FT256BC	256	3.3	5	ftBGA	256	160	С
	LC4256V-75FT256BC	256	3.3	7.5	ftBGA	256	160	С
	LC4256V-3F256AC1	256	3.3	3	fpBGA	256	128	С
	LC4256V-5F256AC1	256	3.3	5	fpBGA	256	128	С
	LC4256V-75F256AC1	256	3.3	7.5	fpBGA	256	128	С
	LC4256V-3F256BC ¹	256	3.3	3	fpBGA	256	160	С
LC4256V	LC4256V-5F256BC ¹	256	3.3	5	fpBGA	256	160	С
	LC4256V-75F256BC1	256	3.3	7.5	fpBGA	256	160	С
	LC4256V-3T176C	256	3.3	3	TQFP	176	128	С
	LC4256V-5T176C	256	3.3	5	TQFP	176	128	С
	LC4256V-75T176C	256	3.3	7.5	TQFP	176	128	С
	LC4256V-3T144C	256	3.3	3	TQFP	144	96	С
	LC4256V-5T144C	256	3.3	5	TQFP	144	96	С
	LC4256V-75T144C	256	3.3	7.5	TQFP	144	96	С
	LC4256V-3T100C	256	3.3	3	TQFP	100	64	С
	LC4256V-5T100C	256	3.3	5	TQFP	100	64	С
	LC4256V-75T100C	256	3.3	7.5	TQFP	100	64	С
	LC4384V-35FT256C	384	3.3	3.5	ftBGA	256	192	С
	LC4384V-5FT256C	384	3.3	5	ftBGA	256	192	С
	LC4384V-75FT256C	384	3.3	7.5	ftBGA	256	192	С
	LC4384V-35F256C1	384	3.3	3.5	fpBGA	256	192	С
LC4384V	LC4384V-5F256C ¹	384	3.3	5	fpBGA	256	192	С
	LC4384V-75F256C1	384	3.3	7.5	fpBGA	256	192	С
	LC4384V-35T176C	384	3.3	3.5	TQFP	176	128	С
	LC4384V-5T176C	384	3.3	5	TQFP	176	128	С
	LC4384V-75T176C	384	3.3	7.5	TQFP	176	128	С

ispMACH 4000V (3.3V) Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
	LC4512V-35FT256C	512	3.3	3.5	ftBGA	256	208	С
	LC4512V-5FT256C	512	3.3	5	ftBGA	256	208	С
	LC4512V-75FT256C	512	3.3	7.5	ftBGA	256	208	С
	LC4512V-35F256C ¹	512	3.3	3.5	fpBGA	256	208	С
LC4512V	LC4512V-5F256C1	512	3.3	5	fpBGA	256	208	С
	LC4512V-75F256C1	512	3.3	7.5	fpBGA	256	208	С
	LC4512V-35T176C	512	3.3	3.5	TQFP	176	128	С
	LC4512V-5T176C	512	3.3	5	TQFP	176	128	С
	LC4512V-75T176C	512	3.3	7.5	TQFP	176	128	С

^{1.} Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Industrial Devices

Family	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
	LC4032V-5T48I	32	3.3	5	TQFP	48	32	I
	LC4032V-75T48I	32	3.3	7.5	TQFP	48	32	I
LC4032V	LC4032V-10T48I	32	3.3	10	TQFP	48	32	1
LC4032V	LC4032V-5T44I	32	3.3	5	TQFP	44	30	I
	LC4032V-75T44I	32	3.3	7.5	TQFP	44	30	1
	LC4032V-10T44I	32	3.3	10	TQFP	44	30	I
	LC4064V-5T100I	64	3.3	5	TQFP	100	64	1
	LC4064V-75T100I	64	3.3	7.5	TQFP	100	64	1
	LC4064V-10T100I	64	3.3	10	TQFP	100	64	I
	LC4064V-5T48I	64	3.3	5	TQFP	48	32	1
LC4064V	LC4064V-75T48I	64	3.3	7.5	TQFP	48	32	I
	LC4064V-10T48I	64	3.3	10	TQFP	48	32	I
	LC4064V-5T44I	64	3.3	5	TQFP	44	30	1
	LC4064V-75T44I	64	3.3	7.5	TQFP	44	30	I
	LC4064V-10T44I	64	3.3	10	TQFP	44	30	I
	LC4128V-5T144I	128	3.3	5	TQFP	144	96	I
	LC4128V-75T144I	128	3.3	7.5	TQFP	144	96	I
	LC4128V-10T144I	128	3.3	10	TQFP	144	96	I
	LC4128V-5T128I	128	3.3	5	TQFP	128	92	1
LC4128V	LC4128V-75T128I	128	3.3	7.5	TQFP	128	92	I
	LC4128V-10T128I	128	3.3	10	TQFP	128	92	I
	LC4128V-5T100I	128	3.3	5	TQFP	100	64	I
	LC4128V-75T100I	128	3.3	7.5	TQFP	100	64	I
	LC4128V-10T100I	128	3.3	10	TQFP	100	64	I

ispMACH 4000V (3.3V) Industrial Devices (Cont.)

LC4256V-5FT256AI 256 3.3 5 ftBGA 256 128 I	Family	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4256V-10FT256AI 256 3.3 10 fil8GA 256 128 I		LC4256V-5FT256AI	256	3.3	5	ftBGA	256	128	I
LC4256V-5FT256BI 256 3.3 5 ftBGA 256 160 1		LC4256V-75FT256AI	256	3.3	7.5	ftBGA	256	128	I
LC4256V-75FT256BI 256 3.3 7.5 ftBGA 256 160 I		LC4256V-10FT256AI	256	3.3	10	ftBGA	256	128	I
LC4256V-10FT256BI 256 3.3 10 ftBGA 256 160 1		LC4256V-5FT256BI	256	3.3	5	ftBGA	256	160	I
LC4256V-5F256AI		LC4256V-75FT256BI	256	3.3	7.5	ftBGA	256	160	I
LC4256V-75F256AI		LC4256V-10FT256BI	256	3.3	10	ftBGA	256	160	I
LC4256V-10F256AI' 256		LC4256V-5F256AI ¹	256	3.3	5	fpBGA	256	128	I
LC4256V-5F256BI		LC4256V-75F256AI ¹	256	3.3	7.5	fpBGA	256	128	I
LC4256V LC4256V-75F256Bl 256 3.3 7.5 fpBGA 256 160 1 LC4256V-10F256Bl 256 3.3 10 fpBGA 256 160 1 LC4256V-51776l 256 3.3 5 TOFP 176 128 1 LC4256V-51776l 256 3.3 7.5 TOFP 176 128 1 LC4256V-10T176l 256 3.3 10 TOFP 176 128 1 LC4256V-10T176l 256 3.3 10 TOFP 176 128 1 LC4256V-51144l 256 3.3 5 TOFP 176 128 1 LC4256V-51144l 256 3.3 7.5 TOFP 144 96 1 LC4256V-10T144l 256 3.3 10 TOFP 144 96 1 LC4256V-10T144l 256 3.3 10 TOFP 144 96 1 LC4256V-75T100l 256 3.3 7.5 TOFP 100 64 1 LC4256V-10T100l 256 3.3 7.5 TOFP 100 64 1 LC4256V-10T100l 256 3.3 10 TOFP 100 64 1 LC4384V-75F1256l 384 3.3 5 ftBGA 256 192 1 LC4384V-75F256l 384 3.3 7.5 ftBGA 256 192 1 LC4384V-10F1256l 384 3.3 7.5 ftBGA 256 192 1 LC4384V-10F1256l 384 3.3 7.5 ftBGA 256 192 1 LC4384V-57176l 384 3.3 7.5 ftBGA 256 192 1 LC4384V-57176l 384 3.3 7.5 ftBGA 256 192 1 LC4384V-57176l 384 3.3 7.5 ftBGA 256 208 1 LC4512V-57E256l 512 3.3 5 ftBGA 256 208 1 L		LC4256V-10F256AI ¹	256	3.3	10	fpBGA	256	128	I
LC4256V-10F256BI		LC4256V-5F256BI ¹	256	3.3	5	fpBGA	256	160	I
LC4256V-5T176 256 3.3 5 TQFP 176 128 I	LC4256V	LC4256V-75F256BI ¹	256	3.3	7.5	fpBGA	256	160	I
LC4256V-75T176 256 3.3 7.5 TQFP 176 128 I		LC4256V-10F256BI ¹	256	3.3	10	fpBGA	256	160	I
LC4256V-10T176 256 3.3 10 TQFP 176 128		LC4256V-5T176I	256	3.3	5	TQFP	176	128	I
LC4256V-5T144I		LC4256V-75T176I	256	3.3	7.5	TQFP	176	128	I
LC4256V-75T144 256 3.3 7.5 TQFP 144 96 1		LC4256V-10T176I	256	3.3	10	TQFP	176	128	I
LC4256V-10T144I		LC4256V-5T144I	256	3.3	5	TQFP	144	96	I
LC4256V-5T100I 256 3.3 5 TQFP 100 64 I		LC4256V-75T144I	256	3.3	7.5	TQFP	144	96	I
LC4256V-75T100I 256 3.3 7.5 TQFP 100 64 I		LC4256V-10T144I	256	3.3	10	TQFP	144	96	I
LC4256V-10T100I 256 3.3 10 TQFP 100 64 I		LC4256V-5T100I	256	3.3	5	TQFP	100	64	I
LC4384V-5FT256 384 3.3 5 ftBGA 256 192 1		LC4256V-75T100I	256	3.3	7.5	TQFP	100	64	I
LC4384V-75FT256 384 3.3 7.5 ftBGA 256 192 LC4384V-10FT256 384 3.3 10 ftBGA 256 192 LC4384V-5F256 384 3.3 5 fpBGA 256 192 LC4384V-75F256 384 3.3 7.5 fpBGA 256 192 LC4384V-10F256 384 3.3 7.5 fpBGA 256 192 LC4384V-10F256 384 3.3 7.5 fpBGA 256 192 LC4384V-10F256 384 3.3 10 fpBGA 256 192 LC4384V-5T176 384 3.3 5 TQFP 176 128 LC4384V-75T176 384 3.3 7.5 TQFP 176 128 LC4384V-10T176 384 3.3 7.5 TQFP 176 128 LC4384V-10T176 384 3.3 10 TQFP 176 128 LC4512V-5FT256 512 3.3 5 ftBGA 256 208 LC4512V-75FT256 512 3.3 7.5 ftBGA 256 208 LC4512V-10FT256 512 3.3 7.5 ftBGA 256 208 LC4512V-10FT256 512 3.3 5 fpBGA 256 208 LC4512V-75F256 512 3.3 7.5 fpBGA 256 208 LC4512V-75F256 512 3.3 7.5 fpBGA 256 208 LC4512V-10F256 512 3.3 7.5 fpBG		LC4256V-10T100I	256	3.3	10	TQFP	100	64	I
LC4384V-10FT256I 384 3.3 10 ftBGA 256 192 I LC4384V-5F256I¹ 384 3.3 5 fpBGA 256 192 I LC4384V-75F256I¹ 384 3.3 7.5 fpBGA 256 192 I LC4384V-10F256I¹ 384 3.3 10 fpBGA 256 192 I LC4384V-5T176I 384 3.3 5 TQFP 176 128 I LC4384V-75T176I 384 3.3 7.5 TQFP 176 128 I LC4384V-10T176I 384 3.3 10 TQFP 176 128 I LC4384V-10T176I 384 3.3 5 ftBGA 256 208 I LC4512V-5FT256I 512 3.3 5 ftBGA 256 208 I LC4512V-75F256I¹ 512 3.3 5 fpBGA 256 208 I LC4512V-75F256I¹ 512 3.3 5 fpBGA 256 208 I LC4512V-75F256I¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256I¹ 512 3.3 5 fpBGA 256 208 I LC4512V-10F256I¹ 512 3.3 5 fpBGA 256 208 I LC4512V-10F256I¹ 512 3.3 5 fpBGA 256 208 I LC4512V-5F176I 512 3.3 5 TQFP 176 128 I LC4512V-5T176I 512 3.3 5 TQFP 176 128 I		LC4384V-5FT256I	384	3.3	5	ftBGA	256	192	I
LC4384V-5F256l ¹ 384 3.3 5 fpBGA 256 192 I LC4384V-75F256l ¹ 384 3.3 7.5 fpBGA 256 192 I LC4384V-10F256l ¹ 384 3.3 10 fpBGA 256 192 I LC4384V-5T176l 384 3.3 5 TQFP 176 128 I LC4384V-10T176l 384 3.3 7.5 TQFP 176 128 I LC4384V-10T176l 384 3.3 10 TQFP 176 128 I LC4384V-10T176l 384 3.3 5 ftBGA 256 208 I LC4512V-5FT256l 512 3.3 7.5 ftBGA 256 208 I LC4512V-75FT256l 512 3.3 5 fpBGA 256 208 I LC4512V-10FT256l 512 3.3 5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 7.5 fpBGA 256 208 I		LC4384V-75FT256I	384	3.3	7.5	ftBGA	256	192	I
LC4384V LC4384V-75F256l¹ 384 3.3 7.5 fpBGA 256 192 I LC4384V-10F256l¹ 384 3.3 10 fpBGA 256 192 I LC4384V-5T176l 384 3.3 5 TQFP 176 128 I LC4384V-75T176l 384 3.3 7.5 TQFP 176 128 I LC4384V-10T176l 384 3.3 10 TQFP 176 128 I LC4512V-5FT256l 512 3.3 5 ftBGA 256 208 I LC4512V-75FT256l 512 3.3 7.5 ftBGA 256 208 I LC4512V-10FT256l 512 3.3 10 ftBGA 256 208 I LC4512V-5F256l¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256l¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256		LC4384V-10FT256I	384	3.3	10	ftBGA	256	192	I
LC4384V-10F256l ¹ 384 3.3 10 fpBGA 256 192 I		LC4384V-5F256I ¹	384	3.3	5	fpBGA	256	192	I
LC4384V-5T176I 384 3.3 5 TQFP 176 128 I LC4384V-75T176I 384 3.3 7.5 TQFP 176 128 I LC4384V-10T176I 384 3.3 10 TQFP 176 128 I LC4512V-5FT256I 512 3.3 5 ftBGA 256 208 I LC4512V-75FT256I 512 3.3 7.5 ftBGA 256 208 I LC4512V-10FT256I 512 3.3 10 ftBGA 256 208 I LC4512V-5F256I¹ 512 3.3 5 fpBGA 256 208 I LC4512V-75F256I¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256I¹ 512 3.3 10 fpBGA 256 208 I LC4512V-5T176I 512 3.3 5 TQFP 176 128 I LC4512V-75T176I 512 3.3 7.5 TQFP 176 128 I	LC4384V	LC4384V-75F256I ¹	384	3.3	7.5	fpBGA	256	192	I
LC4384V-75T176I 384 3.3 7.5 TQFP 176 128 I LC4384V-10T176I 384 3.3 10 TQFP 176 128 I LC4512V-5FT256I 512 3.3 5 ftBGA 256 208 I LC4512V-75FT256I 512 3.3 7.5 ftBGA 256 208 I LC4512V-10FT256I 512 3.3 10 ftBGA 256 208 I LC4512V-5F256I¹ 512 3.3 5 fpBGA 256 208 I LC4512V-75F256I¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256I¹ 512 3.3 10 fpBGA 256 208 I LC4512V-10F256I¹ 512 3.3 10 fpBGA 256 208 I LC4512V-5T176I 512 3.3 5 TQFP 176 128 I LC4512V-75T176I 512 3.3 7.5 TQFP 176 128 I		LC4384V-10F256I ¹	384	3.3	10	fpBGA	256	192	I
LC4384V-10T176 384 3.3 10 TQFP 176 128 I		LC4384V-5T176I	384	3.3	5	TQFP	176	128	I
LC4512V-5FT256I 512 3.3 5 ftBGA 256 208 I LC4512V-75FT256I 512 3.3 7.5 ftBGA 256 208 I LC4512V-10FT256I 512 3.3 10 ftBGA 256 208 I LC4512V-5F256I 512 3.3 5 fpBGA 256 208 I LC4512V-75F256I 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256I 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256I 512 3.3 10 fpBGA 256 208 I LC4512V-10F256I 512 3.3 5 TQFP 176 128 I LC4512V-75T176I 512 3.3 7.5 TQFP 176 128 I		LC4384V-75T176I	384	3.3	7.5	TQFP	176	128	I
LC4512V-75FT256I 512 3.3 7.5 ftBGA 256 208 I LC4512V-10FT256I 512 3.3 10 ftBGA 256 208 I LC4512V-5F256I ¹ 512 3.3 5 fpBGA 256 208 I LC4512V-75F256I ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-75F256I ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256I ¹ 512 3.3 10 fpBGA 256 208 I LC4512V-5T176I 512 3.3 5 TQFP 176 128 I LC4512V-75T176I 512 3.3 7.5 TQFP 176 128 I		LC4384V-10T176I	384	3.3	10	TQFP	176	128	I
LC4512V-10FT256I 512 3.3 10 ftBGA 256 208 I LC4512V-5F256I ¹ 512 3.3 5 fpBGA 256 208 I LC4512V-75F256I ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256I ¹ 512 3.3 10 fpBGA 256 208 I LC4512V-10F256I ¹ 512 3.3 5 TQFP 176 128 I LC4512V-75T176I 512 3.3 7.5 TQFP 176 128 I		LC4512V-5FT256I	512	3.3	5	ftBGA	256	208	I
LC4512V-5F256l ¹ 512 3.3 5 fpBGA 256 208 I LC4512V-75F256l ¹ 512 3.3 7.5 fpBGA 256 208 I LC4512V-10F256l ¹ 512 3.3 10 fpBGA 256 208 I LC4512V-5T176l 512 3.3 5 TQFP 176 128 I LC4512V-75T176l 512 3.3 7.5 TQFP 176 128 I		LC4512V-75FT256I	512	3.3	7.5	ftBGA	256	208	I
LC4512V		LC4512V-10FT256I	512	3.3	10	ftBGA	256	208	I
LC4512V-10F256l¹ 512 3.3 10 fpBGA 256 208 I LC4512V-5T176l 512 3.3 5 TQFP 176 128 I LC4512V-75T176l 512 3.3 7.5 TQFP 176 128 I		LC4512V-5F256I ¹	512	3.3	5	fpBGA	256	208	I
LC4512V-5T176I 512 3.3 5 TQFP 176 128 I LC4512V-75T176I 512 3.3 7.5 TQFP 176 128 I	LC4512V	LC4512V-75F256I ¹	512	3.3	7.5	fpBGA	256	208	I
LC4512V-75T176I 512 3.3 7.5 TQFP 176 128 I		LC4512V-10F256I1	512	3.3	10	fpBGA	256	208	I
		LC4512V-5T176I	512	3.3	5	TQFP	176	128	I
LC4512V-10T176I 512 3.3 10 TQFP 176 128 I		LC4512V-75T176I	512	3.3	7.5	TQFP	176	128	I
		LC4512V-10T176I	512	3.3	10	TQFP	176	128	I

Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Extended Temperature Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-75T48E	32	3.3	7.5	TQFP	48	32	Е
LU4032V	LC4032V-75T44E	32	3.3	7.5	TQFP	44	30	Е
	LC4064V-75T100E	64	3.3	7.5	TQFP	100	64	Е
LC4064V	LC4064V-75T48E	64	3.3	7.5	TQFP	48	32	Е
	LC4064V-75T44E	64	3.3	7.5	TQFP	44	30	Е
	LC4128V-75T144E	128	3.3	7.5	TQFP	144	96	Е
LC4128V	LC4128V-75T128E	128	3.3	7.5	TQFP	128	92	Е
	LC4128V-75T100E	128	3.3	7.5	TQFP	100	64	Е
	LC4256V-75T176E	256	3.3	7.5	TQFP	176	128	Е
LC4256V	LC4256V-75T144E	256	3.3	7.5	TQFP	144	96	Е
	LC4256V-75T100E	256	3.3	7.5	TQFP	100	64	Е

ispMACH 4000B (2.5V) Lead-Free Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
	LC4384B-35FTN256C	384	2.5	3.5	Lead-Free ftBGA	256	192	С
	LC4384B-5FTN256C	384	2.5	5	Lead-Free ftBGA	256	192	С
	LC4384B-75FTN256C	384	2.5	7.5	Lead-Free ftBGA	256	192	С
	LC4384B-35FN256C1	384	2.5	3.5	Lead-Free fpBGA	256	192	С
LC4384B	LC4384B-5FN256C ¹	384	2.5	5	Lead-Free fpBGA	256	192	С
	LC4384B-75FN256C ¹	384	2.5	7.5	Lead-Free fpBGA	256	192	С
	LC4384B-35TN176C	384	2.5	3.5	Lead-Free TQFP	176	128	С
	LC4384B-5TN176C	384	2.5	5	Lead-Free TQFP	176	128	С
	LC4384B-75TN176C	384	2.5	7.5	Lead-Free TQFP	176	128	С
	LC4512B-35FTN256C	512	2.5	3.5	Lead-Free ftBGA	256	208	С
	LC4512B-5FTN256C	512	2.5	5	Lead-Free ftBGA	256	208	С
	LC4512B-75FTN256C	512	2.5	7.5	Lead-Free ftBGA	256	208	С
	LC4512B-35FN256C1	512	2.5	3.5	Lead-Free fpBGA	256	208	С
LC4512B	LC4512B-5FN256C1	512	2.5	5	Lead-Free fpBGA	256	208	С
	LC4512B-75FN256C1	512	2.5	7.5	Lead-Free fpBGA	256	208	С
	LC4512B-35TN176C	512	2.5	3.5	Lead-Free TQFP	176	128	С
	LC4512B-5TN176C	512	2.5	5	Lead-Free TQFP	176	128	С
	LC4512B-75TN176C	512	2.5	7.5	Lead-Free TQFP	176	128	С

^{1.} Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000B (2.5V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
	LC4032B-5TN48I	32	2.5	5	Lead-Free TQFP	48	32	I
	LC4032B-75TN48I	32	2.5	7.5	Lead-Free TQFP	48	32	I
LC4032B	LC4032B-10TN48I	32	2.5	10	Lead-Free TQFP	48	32	I
LC4032B	LC4032B-5TN44I	32	2.5	5	Lead-Free TQFP	44	30	I
	LC4032B-75TN44I	32	2.5	7.5	Lead-Free TQFP	44	30	I
	LC4032B-10TN44I	32	2.5	10	Lead-Free TQFP	44	30	I
	LC4064B-5TN100I	64	2.5	5	Lead-Free TQFP	100	64	I
	LC4064B-75TN100I	64	2.5	7.5	Lead-Free TQFP	100	64	I
	LC4064B-10TN100I	64	2.5	10	Lead-Free TQFP	100	64	I
	LC4064B-5TN48I	64	2.5	5	Lead-Free TQFP	48	32	I
LC4064B	LC4064B-75TN48I	64	2.5	7.5	Lead-Free TQFP	48	32	I
	LC4064B-10TN48I	64	2.5	10	Lead-Free TQFP	48	32	I
	LC4064B-5TN44I	64	2.5	5	Lead-Free TQFP	44	30	I
	LC4064B-75TN44I	64	2.5	7.5	Lead-Free TQFP	44	30	I
	LC4064B-10TN44I	64	2.5	10	Lead-Free TQFP	44	30	I

ispMACH 4000V (3.3V) Lead-Free Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
	LC4256V-3FTN256AC	256	3.3	3	Lead-free ftBGA	256	128	С
	LC4256V-5FTN256AC	256	3.3	5	Lead-free ftBGA	256	128	С
	LC4256V-75FTN256AC	256	3.3	7.5	Lead-free ftBGA	256	128	С
	LC4256V-3FTN256BC	256	3.3	3	Lead-free ftBGA	256	160	С
	LC4256V-5FTN256BC	256	3.3	5	Lead-free ftBGA	256	160	С
	LC4256V-75FTN256BC	256	3.3	7.5	Lead-free ftBGA	256	160	С
	LC4256V-3FN256AC1	256	3.3	3	Lead-free fpBGA	256	128	С
	LC4256V-5FN256AC1	256	3.3	5	Lead-free fpBGA	256	128	С
	LC4256V-75FN256AC1	256	3.3	7.5	Lead-free fpBGA	256	128	С
	LC4256V-3FN256BC1	256	3.3	3	Lead-free fpBGA	256	160	С
LC4256V	LC4256V-5FN256BC ¹	256	3.3	5	Lead-free fpBGA	256	160	С
	LC4256V-75FN256BC ¹	256	3.3	7.5	Lead-free fpBGA	256	160	С
	LC4256V-3TN176C	256	3.3	3	Lead-free TQFP	176	128	С
	LC4256V-5TN176C	256	3.3	5	Lead-free TQFP	176	128	С
	LC4256V-75TN176C	256	3.3	7.5	Lead-free TQFP	176	128	С
	LC4256V-3TN144C	256	3.3	3	Lead-free TQFP	144	96	С
	LC4256V-5TN144C	256	3.3	5	Lead-free TQFP	144	96	С
	LC4256V-75TN144C	256	3.3	7.5	Lead-free TQFP	144	96	С
	LC4256V-3TN100C	256	3.3	3	Lead-free TQFP	100	64	С
	LC4256V-5TN100C	256	3.3	5	Lead-free TQFP	100	64	С
	LC4256V-75TN100C	256	3.3	7.5	Lead-free TQFP	100	64	С
	LC4384V-35FTN256C	384	3.3	3.5	Lead-free ftBGA	256	192	С
	LC4384V-5FTN256C	384	3.3	5	Lead-free ftBGA	256	192	С
	LC4384V-75FTN256C	384	3.3	7.5	Lead-free ftBGA	256	192	С
	LC4384V-35FN256C1	384	3.3	3.5	Lead-free fpBGA	256	192	С
LC4384V	LC4384V-5FN256C ¹	384	3.3	5	Lead-free fpBGA	256	192	С
	LC4384V-75FN256C1	384	3.3	7.5	Lead-free fpBGA	256	192	С
	LC4384V-35TN176C	384	3.3	3.5	Lead-free TQFP	176	128	С
	LC4384V-5TN176C	384	3.3	5	Lead-free TQFP	176	128	С
	LC4384V-75TN176C	384	3.3	7.5	Lead-free TQFP	176	128	С
	LC4512V-35FTN256C	512	3.3	3.5	Lead-free ftBGA	256	208	С
	LC4512V-5FTN256C	512	3.3	5	Lead-free ftBGA	256	208	С
	LC4512V-75FTN256C	512	3.3	7.5	Lead-free ftBGA	256	208	С
	LC4512V-35FN256C1	512	3.3	3.5	Lead-free fpBGA	256	208	С
LC4512V	LC4512V-5FN256C ¹	512	3.3	5	Lead-free fpBGA	256	208	С
	LC4512V-75FN256C ¹	512	3.3	7.5	Lead-free fpBGA	256	208	С
	LC4512V-35TN176C	512	3.3	3.5	Lead-free TQFP	176	128	С
	LC4512V-5TN176C	512	3.3	5	Lead-free TQFP	176	128	С
	LC4512V-75TN176C	512	3.3	7.5	Lead-free TQFP	176	128	С

^{1.} Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Lead-Free Extended	Temperature Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-75TN48E	32	3.3	7.5	Lead-free TQFP	48	32	Е
LO4032V	LC4032V-75TN44E	32	3.3	7.5	Lead-free TQFP	44	30	Е
	LC4064V-75TN100E	64	3.3	7.5	Lead-free TQFP	100	64	Е
LC4064V	LC4064V-75TN48E	64	3.3	7.5	Lead-free TQFP	48	32	Е
	LC4064V-75TN44E	64	3.3	7.5	Lead-free TQFP	44	30	Е
	LC4128V-75TN144E	128	3.3	7.5	Lead-free TQFP	144	96	Е
LC4128V	LC4128V-75TN128E	128	3.3	7.5	Lead-free TQFP	128	92	Е
	LC4128V-75TN100E	128	3.3	7.5	Lead-free TQFP	100	64	Е
	LC4256V-75TN176E	256	3.3	7.5	Lead-free TQFP	176	128	Е
LC4256V	LC4256V-75TN144E	256	3.3	7.5	Lead-free TQFP	144	96	E
	LC4256V-75TN100E	256	3.3	7.5	Lead-free TQFP	100	64	E

For Further Information

In addition to this data sheet, the following technical notes may be helpful when designing with the ispMACH 4000V/B/C/Z family:

- TN1004, ispMACH 4000 Timing Model Design and Usage Guidelines
- TN1005, Power Estimation in ispMACH 4000V/B/C/Z Devices

Revision History

Date	Version	Change Summary
_	_	Previous Lattice releases.
July 2003	17z	Changed device status for LC4064ZC and LC4128ZC to production release and updated/added AC and DC parameters as well as ordering part numbers for LC4064ZC and LC4128ZC devices.
		Improved leakage current specifications for ispMACH 4000Z. For ispMACH 4000V/B/C IIL, IIH condition now includes 0V and 3.6V end points ($0 \le VIN \le 3.6V$).
		Added 132-ball chip scale BGA power supply and NC connections.
		Added 132-ball chip scale BGA logic signal connections for LC4064ZC, LC4128ZC and LC4256ZC devices.
		Added lead-free package designators.
October 2003	18z	Hot socketing characteristics footnote 1. has been enhanced; Insensitive to sequence of VCC or VCCO. However, assumes monotonic rise/fall rates for Vcc and Vcco, provided (VIN - VCCO) ≤ 3.6V.
		Improved LC4064ZC t_S to 2.5ns, t_{ST} to 2.7ns and f_{MAX} (Ext.) to 175MHz, LC4128ZC t_{CO} to 3.5ns and f_{MAX} (Ext.) to 161MHz (version v.2.1).
		Improved associated internal timing numbers and timing adders (version v.2.1).
		Added ispMACH 4000V/B/C/Z ORP Reference Tables.
		Enhanced ORP information in device pinout tables consistent with the ORP Combinations for I/O Blocks tables (table 6, 7, 8 and 9 in page 9-11).
		Corrected GLB/MC/Pad information in the 256-fpBGA pinouts for the LC4256V/B/C 160-I/O version.
		Added the ispMACH 4000 Family Speed Grade Offering table.
		Added the ispMACH 4128ZC Industrial and Automotive Device OPNs
December 2003	19z	Added the ispMACH 4032ZC and 4064ZC Industrial and Automotive Device OPNs